

# 4-Pin µP Voltage Monitors with Manual Reset Input UM805/811/812 SOT143

## **General Description**

The UM805/811/812 are low-power microprocessor ( $\mu$ P) supervisory circuits used to monitor power supplies in  $\mu$ P and digital systems. They provide excellent circuit reliability and low cost by eliminating external components and adjustments when used with 5V-powered or 3V-powered circuits. The UM805/811/812 also provide a debounced manual reset input.

These devices perform a single function: They assert a reset signal whenever the  $V_{CC}$  supply voltage falls below a preset threshold, keeping it asserted for at least 140ms after  $V_{CC}$  has risen above the reset threshold. Reset thresholds are available for operation with a variety of supply voltages.

The UM805 has an open-drain output stage, while the UM811/812 have push-pull outputs. The UM805's open-drain RESET output requires a pull-up resistor that can be connected to a voltage higher than  $V_{CC}$ . The UM805/811 have an active-low RESET output, while the UM812 has an active-high RESET output. The reset comparator is designed to ignore fast transients on  $V_{CC}$ , and the outputs are guaranteed to be in the correct logic state for  $V_{CC}$  down to 1V.

Low supply current makes the UM805/811/812 ideal for use in portable equipments. The devices come in a 4-pin SOT143 package.

#### Applications

#### Features

- Computers
- Controllers
- Portable/Battery-Powered Equipments
- Intelligent Instruments
- Critical µP and µC Power Monitoring
- No External Components
- V<sub>CC</sub> Transient Immunity
- Correct Logic Output Guaranteed to V<sub>CC</sub>=1.0V
- Precision  $V_{CC}$  Monitoring of 3.0V, 3.3V and 5.0V Supplies
- 2μA Supply Current
- 140ms Minimum Power-On Reset Pulse Width
- Guaranteed Over Temperature
- Available in 3 Output Configurations: Open-Drain Active-Low RESET Output (UM805) Push-Pull Active-Low RESET Output (UM811) Push-Pull Active-High RESET Output (UM812)
- 4-Pin SOT143 Package
- Wide Operation Temperature: -40°C to +85°C



#### **Pin Configurations**

**Top View** 



## **Ordering Information**

- UM8 <u>XX Z P</u>
- XX: Output Type
- =05 Open-Drain Active Low
- =11 Push-Pull Active Low
- =12 Push-Pull Active High
- Z: Reset Threshold (V)
- =L 4.63
- =M 4.38
- =J 4.00
- =T 3.08
- =S 2.93
- =R 2.63
- =Z 2.32
- P: Package Type
- =E SOT143

## **Typical Operating Circuit**





### **Pin Description**

Pin Number	Pin Name	Function	
1	GND	Ground	
2	RESET (UM805/811) RESET (UM812)	Active-Low Reset Output. $\overrightarrow{RESET}$ remains low while $V_{CC}$ is below the reset threshold or while $\overrightarrow{MR}$ is held low. It remains low for the Reset Active Timeout Period $(t_{RP})$ after the reset conditions are terminated. See Figure 1. UM811: CMOS push-pull output (sources and sinks current). UM805: Open-drain, active low, NMOS output (sinks current only). Connect a pull-up resistor from $\overrightarrow{RESET}$ to any supply voltage up to 6V. Active-High Reset Output. $\overrightarrow{RESET}$ remains high while $V_{CC}$ is below the reset threshold or while $\overrightarrow{MR}$ is held low. RESET remains high for Reset Active Timeout Period $(t_{RP})$ after the reset conditions are terminated.	
3	MR	Manual Reset Input. A logic low on $\overline{MR}$ asserts reset. Reset remains asserted as long as $\overline{MR}$ is low and for 240ms after $\overline{MR}$ returns high. This active-low input has an internal 20k $\Omega$ pull-up resistor. It can be driven from a TTL or CMOS-logic line, or shorted to ground with a switch. Leave open if unused. See Figure 2.	
4	V <sub>CC</sub>	+5V, +3.3V or +3V Supply Voltage	

## Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	-0.3 to +6.0	
	RESET, RESET (Push-Pull)	-0.3 to ( $V_{CC}$ +0.3)	V
	RESET (Open-Drain)	-0.3 to +6.0	
I <sub>CC</sub>	Input Current, $V_{CC}$ , $\overline{MR}$	20	mA
Io	Output Current, RESET, RESET	20	mA
P <sub>D</sub>	Continuous Power Dissipation (Derate 4mW/°C above 70°C)	320	mW
T <sub>A</sub>	Operating Temperature Range	-40 to +105	°C
T <sub>STG</sub>	Storage Temperature Range	-65 to +160	°C
	Lead Temperature (Soldering, 10s)	+300	°C

Note 1: Stresses beyond those listed under "Absolute maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



### **Electrical Characteristics**

(V<sub>CC</sub>=5V for L/M/J versions, V<sub>CC</sub>=3.3V for T/S versions, V<sub>CC</sub>=3V for R version, and V<sub>CC</sub>=2.5V for Z version,  $T_A$ =-40°C to +85°C, unless otherwise noted. Typical values are at  $T_A$ =+25°C.) (Note 2)

Symbol	Parameter	(	Conditions	Min	Тур	Max	Unit
$V_{CC}$	Supply Voltage Range	$T_A=0^{\circ}C$ to $+70^{\circ}C$		1.0		5.5	V
I <sub>CC</sub>	Supply Current				2.0	5.0	μΑ
		I. Varaian	T <sub>A</sub> =+25°C	4.56	4.63	4.70	
		L Version	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	4.50		4.75	-
			T <sub>A</sub> =+25°C	4.31	4.38	4.45	
		M Version	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	4.25		4.50	
			T <sub>A</sub> =+25°C	3.93	4.00	4.06	
		J Version	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	3.89		4.10	
$V_{\mathrm{TH^{+}}}$	Reset Threshold	T.V	T <sub>A</sub> =+25°C	3.04	3.08	3.11	v
• 111+		T Version	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	3.00		3.15	
		0.W .	T <sub>A</sub> =+25°C	2.89	2.93	2.96	
		S Version	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	2.85		3.00	-
		DV ·	T <sub>A</sub> =+25°C	2.59	2.63	2.66	
		R Version	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	2.55		2.70	
		Z Version	T <sub>A</sub> =+25°C	2.28	2.32	2.35	
			$T_A = -40^{\circ}C$ to $+85^{\circ}C$	2.25		2.38	
	Reset Threshold Tempco				150		ppm/°C
	$V_{CC}$ to Reset Delay				10		
	(Note 3)				10		μs
t <sub>RP</sub>	Reset Active Timeout Period			140	240	560	ms
+	MR Minimum			10			μs
t <sub>MR</sub>	Pulse Width			10			P**
	MR Glitch Immunity (Note 4)				100		ns
t <sub>MD</sub>	MR to Reset				0.5		μs
	Propagation Delay						
$V_{\mathrm{IH}}$	4	$V_{CC} > V_{TH(MAX)}$		2.3			
V <sub>IL</sub>	MR Input	$V_{CC} > V_{TH(MAX)}$				0.8	v
$V_{\mathrm{IH}}$	Threshold			$0.7 \times V_{CC}$			
$V_{IL}$		UM805/8	811/812TE/SE/RE/ZE			$0.25 \times V_{CC}$	
	MR Pull-Up Resistance			10	20	30	kΩ



## **Electrical Characteristics (Continued)**

(V<sub>CC</sub>=5V for L/M/J versions, V<sub>CC</sub>=3.3V for T/S versions, V<sub>CC</sub>=3V for R version, and V<sub>CC</sub>=2.5V for Z version,  $T_A$ =-40°C to +85°C, unless otherwise noted. Typical values are at  $T_A$ =+25°C.) (Note 2)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>OH</sub>		I <sub>SOURCE</sub> =150µA, 1.8V <v<sub>CC<v<sub>TH(MIN) UM812LE/ME/JE/TE/SE/RE/ZE</v<sub></v<sub>				
Vol	RESET Output Voltage	I <sub>SINK</sub> =1.2mA UM812TE/SE/RE/ZE			0.3	
V OL		I <sub>SINK</sub> =3.2mA UM812LE/ME/JE			0.4	
V	RESET Output Voltage	I <sub>SOURCE</sub> =500µA, V <sub>CC</sub> >V <sub>TH(MAX)</sub> UM811TE/SE/RE/ZE	$0.8 \times V_{CC}$			
V <sub>OH</sub>		I <sub>SOURCE</sub> =800µA, V <sub>CC</sub> >V <sub>TH(MAX)</sub> UM811LE/ME/JE	V <sub>CC</sub> -1.5			
		I <sub>SINK</sub> =1.2mA, V <sub>CC</sub> =V <sub>TH(MIN)</sub> UM805/811TE/SE/RE/ZE			0.3	V
V <sub>OL</sub>		I <sub>SINK</sub> =3.2mA, V <sub>CC</sub> =V <sub>TH(MIN)</sub> UM805/811LE/ME/JE			0.4	
		I <sub>SINK</sub> =50μA, V <sub>CC</sub> >1.0V			0.3	

**Note 2:** Production testing done at  $T_A$ =+25°C; limits over temperature guaranteed by design only. **Note 3:** RESET output for UM805/811; RESET output for UM812.

Note 4: "Glitches" of 100ns or less typically will not generate a reset pulse.



## **Typical Operating Characteristics**

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 





Power-up RESET Timeout vs. Temperature





### **Detailed Description**

#### **RESET Timing**

The reset signal is asserted LOW for the UM811 and HIGH for the UM812 when the power supply voltage falls below the threshold trip voltage and remains asserted for at least 140ms after the power supply voltage has risen above the threshold.



Figure 1. RESET vs. V<sub>CC</sub> Timing Diagram

The reset signal is asserted LOW for the UM811 and HIGH for the UM812 when  $\overline{MR}$  is low and remains asserted for at least 140ms after  $\overline{MR}$  is high.





#### **Reset Output**

A microprocessor's ( $\mu$ P's) reset input starts the  $\mu$ P in a known state. These  $\mu$ P supervisory circuits assert reset to prevent code execution errors during power-up, power-down, or brownout conditions. RESET is guaranteed to be a logic low for V<sub>CC</sub>>1V. Once V<sub>CC</sub> exceeds the reset threshold, an internal timer keeps RESET low for the reset timeout period; after this interval, RESET goes high.

If a brownout condition occurs (V<sub>CC</sub> dips below the reset threshold), RESET goes low. Any time



 $V_{CC}$  goes below the reset threshold, the internal timer resets to zero, and  $\overline{RESET}$  goes low. The internal timer starts after  $V_{CC}$  returns above the reset threshold, and  $\overline{RESET}$  remains low for the reset timeout period.

The manual reset input  $(\overline{MR})$  can also initiate a reset. See the *Manual Reset Input* section. The UM812 has an active-high RESET output that is the inverse of the UM805/811's RESET output. The UM805 uses an open-drain output, and the UM811/812 have a push-pull output stage. Connect a pull-up resistor on the UM805's RESET output to any supply between 0 and 6V.

#### Manual Reset Input

Many  $\mu$ P-based products require manual reset capability, allowing the operator, a test technician, or external logic circuitry to initiate a reset. A logic low on  $\overline{MR}$  asserts reset. Reset remains asserted while  $\overline{MR}$  is low, and for the Reset Active Timeout Period ( $t_{RP}$ ) after  $\overline{MR}$  returns high. This input has an internal 20k $\Omega$  pull-up resistor, so it can be left open if it is not used.  $\overline{MR}$  can be driven with TTL or CMOS-logic levels, or with open-drain/collector outputs. Connect a normally open momentary switch from  $\overline{MR}$  to GND to create a manual-reset function; external debounce circuitry is not required. If  $\overline{MR}$  is driven from long cables or if the device is used in a noisy environment, connecting a 0.1 $\mu$ F capacitor from  $\overline{MR}$  to ground provides additional noise immunity.

#### **Reset Threshold Accuracy**

The UM805/811/812 are ideal for systems using a  $5V\pm5\%$  or  $3V\pm5\%$  power supply with ICs specified for  $5V\pm10\%$  or  $3V\pm10\%$ , respectively. They are designed to meet worst-case specifications over temperature. The reset is guaranteed to assert after the power supply falls out of regulation, but before power drops below the minimum specified operating voltage range for the system ICs. The thresholds are pre-trimmed and exhibit tight distribution, reducing the range over which an undesirable reset may occur.



#### **Applications Information**

#### **Negative-Going V<sub>CC</sub> Transients**

In addition to issuing a reset to the  $\mu$ P during power-up, power-down, and brownout conditions, the UM805/811/812 are relatively immune to short-duration negative-going V<sub>CC</sub> transients (glitches). Figure 3 shows typical transient duration vs. reset comparator overdrive, for which the UM805/811/812 do not generate a reset pulse. The graph was generated using a negative-going pulse applied to V<sub>CC</sub>, starting above the actual reset threshold and ending below it by the magnitude indicated (reset comparator overdrive). The graph indicates the typical maximum pulse width a negative-going V<sub>CC</sub> transient may have without causing a reset pulse to be issued. As the magnitude of the transient increases (goes farther below the reset threshold), the maximum allowable pulse width decreases. Typically, for the UM8\_\_LE/ME/JE, a V<sub>CC</sub> transient that goes 125mV below the reset threshold and lasts 40µs or less will not cause a reset pulse to be issued. A 0.1µF capacitor mounted as close as possible to the V<sub>CC</sub> provides additional transient immunity.



Figure 3. Maximum Transient Duration without Causing a Reset Pulse vs. Reset Comparator Overdrive

#### Ensuring a Valid $\overline{\text{RESET}}$ Output Down to V<sub>CC</sub>=0V

When  $V_{CC}$  falls below 1V, the UM811 RESET output no longer sinks current—it becomes an open circuit. Therefore, high-impedance CMOS-logic inputs connected to RESET can drift to undetermined voltages. This presents no problem in most applications since most  $\mu$ P and other circuitry is inoperative with  $V_{CC}$  below 1V. However, in applications where RESET must be valid down to 0V, adding a pull-down resistor to RESET pin will causes any stray leakage currents to flow to ground, holding RESET low (Figure 4). R1's value is not critical; 100k $\Omega$  is large enough not to load RESET and small enough to pull RESET to ground.

A 100k $\Omega$  pull-up resistor to V<sub>CC</sub> is also recommended for the UM812 if RESET is required to remain valid for V<sub>CC</sub><1V.





Figure 4. **RESET** Valid to V<sub>CC</sub>=Ground Circuit

#### Interfacing to µPs with Bidirectional Reset Pins

 $\mu$ Ps with bidirectional reset pins (such as the Motorola68HC11 series) can contend with the UM811/812 reset outputs. If, for example, the UM811 RESET output is asserted high and the  $\mu$ P wants to pull it low, indeterminate logic levels may result. To correct such cases, connect a 4.7k $\Omega$  resistor between the UM811 RESET (or UM812 RESET) output and the  $\mu$ P reset I/O (Figure 5). Buffer the reset output to other system components.



Figure 5. Interfacing to µPs with Bidirectional Reset I/O



## UM805 Open-Drain **RESET** Output Allows Use with Multiple Supplies

Generally, the pull-up connected to the UM805 will connect to the supply voltage that is being monitored at the IC's  $V_{CC}$  pin. However, some systems may use the open-drain output to level-shift from the monitored supply to reset circuitry powered by some other supply (Figure 6). Note that as the UM805's  $V_{CC}$  decreases below 1V, so does the IC's ability to sink current at RESET. Also, with any pull-up, RESET will be pulled high as  $V_{CC}$  decays toward 0. The voltage where this occurs depends on the pull-up resistor value and the voltage to which it is connected.



Figure 6. UM805 Open-Drain RESET Output Allows Use with Multiple Supplies





**Outline Drawing** 

## **Package Information**

## UM805/811/812 SOT143



DIMENSIONS						
Ghh	MILLIMETERS			INCHES		
Symbol	Min	Тур	Max	Min	Тур	Max
А	0.80	-	1.22	0.031	-	0.048
A1	0.00	-	0.15	0.000	-	0.006
A2	0.75	-	1.07	0.030	-	0.042
b	0.30	0.40	0.51	0.012	0.016	0.020
b1	0.75	-	0.93	0.030	-	0.037
с	0.08	-	0.20	0.003	-	0.008
d	(	).20TY	Р	0.008TYP		
D	2.80	2.90	3.04	0.110	0.114	0.120
Е	1.20	1.30	1.40	0.047	0.051	0.055
E1	2.20	-	2.64	0.087	-	0.104
e	1.92BSC			0.076BSC		
L	0.30	-	0.60	0.012	-	0.024
θ	0°	-	8°	0°	-	8°

## Land Pattern



#### **Tape and Reel Orientation**





## **Selection Table**

Part Number	RESET Threshold (V)	Timeout Period (ms)	Output Type	Marking Code	Package Type	Shipping Qty
UM805LE	4.63	240	Open-Drain, Active Low	05L		
UM805ME	4.38	240	Open-Drain, Active Low	05M		
UM805JE	4.00	240	Open-Drain, Active Low	05J		
UM805TE	3.08	240	Open-Drain, Active Low	05T		
UM805SE	2.93	240	Open-Drain, Active Low	058		
UM805RE	2.63	240	Open-Drain, Active Low	05R		
UM805ZE	2.32	240	Open-Drain, Active Low	05Z		
UM811LE	4.63	240	Push-Pull, Active Low	11L		
UM811ME	4.38	240	Push-Pull, Active Low	11M		
UM811JE	4.00	240	Push-Pull, Active Low	11J		
UM811TE	3.08	240	Push-Pull, Active Low	11T	SOT143	3000pcs/7Inch Tape & Reel
UM811SE	2.93	240	Push-Pull, Active Low	11S		•
UM811RE	2.63	240	Push-Pull, Active Low	11R		
UM811ZE	2.32	240	Push-Pull, Active Low	11Z		
UM812LE	4.63	240	Push-Pull, Active High	12L		
UM812ME	4.38	240	Push-Pull, Active High	12M		
UM812JE	4.00	240	Push-Pull, Active High	12J		
UM812TE	3.08	240	Push-Pull, Active High	12T		
UM812SE	2.93	240	Push-Pull, Active High	128		
UM812RE	2.63	240	Push-Pull, Active High	12R		
UM812ZE	2.32	240	Push-Pull, Active High	12Z		



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Union Semiconductor, Inc Add: Unit 606, No.570 Shengxia Road, Shanghai 201210 Tel: 021-51093966 Fax: 021-51026018 Website: www.union-ic.com